

Accepted Manuscript

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PII: S0040-6090(17)30803-9
DOI: doi:[10.1016/j.tsf.2017.10.041](https://doi.org/10.1016/j.tsf.2017.10.041)
Reference: TSF 36309

To appear in: *Thin Solid Films*

Received date: 15 December 2016
Revised date: 18 October 2017
Accepted date: 19 October 2017

Please cite this article as: M. Alaya, R. Benabderrahmane Zaghoulani, S. Khamlich, J.-L. Lazzari, W. Dimassi, Enhancement of physical properties of stain-etched porous silicon by integration of WO₃ nanoparticles. The address for the corresponding author was captured as affiliation for all authors. Please check if appropriate. Tsf(2017), doi:[10.1016/j.tsf.2017.10.041](https://doi.org/10.1016/j.tsf.2017.10.041)

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Enhancement of physical properties of stain-etched porous silicon by integration of WO₃ nanoparticles

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Abstract

In this work, we report on the passivation of porous silicon (PS) by tungsten trioxide (WO₃) nanostructured thin films deposited via dip-coating of PS in tungsten hexachloride and water/ethanol solution. Structural analysis by Fourier transform infrared spectroscopy showed a partial disappearance of SiH_x and Si-O-Si peaks after WO₃ thin film deposition on the PS due to the replacement of H atoms by WO₃. Additionally, PS/WO₃ sample revealed weakly intense peaks which can be ascribed to O-W-O and W=O bridging bonds. Morphological analysis by atomic force spectroscopy showed the coverage of the PS surface by a nanostructured thin film of dense WO₃ nanoparticles with a size ranging from 40 to 60 nm. The photoluminescence signal intensity of PS/WO₃ samples presents a continuous increase as a function of the immersion time in the precursor solution. This is attributed to a better decoration of the PS surface by WO₃ nanoplatelets and a decrease of surface recombination velocity (200 x 10² cm/s for untreated silicon, 137 x 10² cm/s for PS and 99 x 10² cm/s for PS/WO₃ samples). Hence, a ~ 50 % improvement in the effective lifetime of minority carriers is obtained. Moreover, the deposited WO₃ contributed not only to the passivation of PS, but acted as an antireflection layer which enhanced the optical properties of PS by reducing the reflection of light. These obtained results confirmed the benefits of using WO₃ thin film as passivation/antireflection coating for possible solar cell application.

Keywords: Porous silicon; Passivation; Tungsten oxide; Photoluminescence; Surface recombination velocity; Minority carrier lifetime.

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